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DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named Inventor, I hereby declare that:

DOCKET NO. TS02-276

· My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Method For Forming Devices With Multiple Spacer Widths

the specification of which (check one)			
X is attached hereto.	·		
was filed on			
Application Serial No.			
and was amended on(if a			
I hereby state that I have reviewed and u amended by any amendment referred to	applicable) understand the contents of the a above.	above Identified specification including	the claims, as
I acknowledge the duty to disclose infon Title 37, Code of Federal Regulations, §	mation which is material to the 1.56(a).	examination of this application in accor	rdance with
I hereby claim foreign priority benefits u inventor's certificate listed below and ha having a filing date before that of the app Prior Foreign Application(s)	under Title 35, United States Cover also identified below any foolication on which priority is c	ode §119 of any foreign application(s) foreign application for patent or inventor laimed:	or patent or s certificate
92115512	TAIWAN	Priority Claimed 09/06/03	;
921)5512 (Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under Title 35, as the subject matter of each of the claims manner provided by the first paragraph of information as defined in Title 37. Code capplication and the national or PC i international or PC i internationa	• •	ny United States application(s) listed bellosed in the prior United States application §112. I acknowledge the duty to disclose a) which occurred between the filing data teation:	ow and, insofar on in the e material e of the prior
(Application Serial No.)	•	(patented, pending, abandoned)	
I hereby declare that all statements made helief are believed to be true; and further the like so made are punishable by fine or and that such willful false statements may	nerein of my own knowledge a that these statements were mad- imprisonment, or both, under jeopardize the validity of the	re true and that all statements made on it le with the knowledge that willful false of Section 1001 of Title 18 of the United S application or any patent issued thereon.	nformation and statements and States Code
POWER OF ATTORNEY: As a named in application and transact all business in the	iventor, I hereby appoint the for Patent and Trademark Office	ollowing attorney(s) and/or agent(s) to preconnected therewith. (list name & regist	rosecute this
GEORGE 0. SAILE. (Reg. No. 1	9,572), STEPHEN B. A(UKERMAN (Reg. No. 37,761)	,
Send Correspondence to: 28 DAVIS AVE	NUE, POUGHKEEPSIE NE	W VORK 12602	
Direct telephone Calls to: (name & telephone	number) GEORGE 0. SAII	LE NEW YORK 845 452 5863	
HOWARD CHIH HAO WANG Full name of sole or first inventor			
Howard Chih-Hao Wang		Date	
		Feb. 11, 2004	
7F. No. 123-5, Lane 89, See Residence	ction 1, Guany-fuh 1	2d., Hsinchu, Taiwan	
Citizenship C. lepublic of the			
No. 8. Li Hsin Rd. 6. Science-Based Indust	trial Park, Hsin-Chu, Taiwan 30	00-77 R.O.C	

DOCKET NO. <u>TS02-276</u>

Full name of second inventor	
	Date
Inventor's signature	2/14/2004
Residence Abble Strive Abril 94507	
USA	
No. 8. Li Mai, D. C. C.	
No. 8. Li-Hsin Rd. 6. Science-Based Industrial Park, Hsin-Chu, Ta	niwan 300-77 R.O.C.
CHUN-CHIEH LIN	
Chun-Chieh I.	Date
OVEDIOL'S Signature	2/11/204
11F1-4, No 21. Lane 23. Guand ung Ro Residence ROC Pepublic of China, Vallettizenship	1. Hsinochu Taiwan 300
Roc Penublic of China	70-
itizenship Republic of Mind	UTO X
No. 8. Li-Hsin Rd. 6. Science-Based Industrial Park, Hsin-Chu, Tairost Office Address	wan 300-77 R.O.C.
ll name of fourth inventor	Date
ventor's signature	
esidence	
tizenship	
st Office Address	
name of tifth inventor	Date
entor's signature	
idence	
zenship	
Office Address	
name of sixth inventor	
	Date
ntor's signature	
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enship	
Office Address	